ALPHA & OMEGA SEMICONDUCTOR 600V, α MOS5 TM N-Channel Power Transistor									
General Description			Product Summary						
 Proprietary αMOS5TM technology Low R_{DS(ON)} Optimized switching parameters for better EMI performance Enhanced body diode for robustness and fast reverse recovery 			$\begin{array}{l} V_{DS} @ T_{j,max} \\ I_{DM} \\ R_{DS(ON),max} \\ Q_{g,typ} \\ E_{oss} @ 400V \end{array}$	700V 80A < 0.19Ω 34nC 4.3μJ					
 Applications SMPS with PFC, Flyback and LLC topologies Silver ATX ,adapter, TV, lighting, Telecom 			100% UIS Tested 100% R _g Tested	Green					
TO-220F									
Orderable Part Numb	Orderable Part Number Packa		Form	Minimum O	rder Quantity				
AOTF190A60L	TO-22	20F Green	Tube	1	000				
Absolute Maximum Ratings	T ₄ =25°C unless	s otherwise no	oted						
Parameter	- A - C - C - C - C - C - C - C - C - C	Symbol	AOTF19	004601	Units				
Drain-Source Voltage		V _{DS}	600		V				
Gate-Source Voltage		V _{GS}	±20		V				
Gate-Source Voltage (dynami	c) AC(f>1Hz)	V _{GS}	±30		V				
Continuous Drain T _C =25°			20*						
Current $T_c=100$		I _D	12*		А				
Pulsed Drain Current C		I _{DM}	80						
Avalanche Current ^C		I _{AR}	5		A				
Repetitive avalanche energy ^C		E _{AR}	12.5		mJ				
Single pulsed avalanche energy ^G		E _{AS}	410		mJ				
MOSFET dv/dt ruggedness		dv/dt	100		V/ns				
Peak diode recovery dv/dt		uviui	20						
T _C =25°C		PD	32		W				
Power Dissipation ^B Derate above 25°C			0.25		W/°C				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150		°C				
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		TL	300		°C				
Thermal Characteristics									

Inermal Characteristics						
Parameter	Symbol	AOTF190A60L	Units			
Maximum Junction-to-Ambient A,D	$R_{ ext{ heta}JA}$	65	°C/W			
Maximum Junction-to-Case	$R_{ ext{ ext{ heta}JC}}$	3.9	°C/W			

* Drain current limited by maximum junction temperature.



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC	PARAMETERS						
BV _{DSS}	Drain Source Breekdourn Vieltoge	I _D =250µA, V _{GS} =0V, T _J =25°C	600	-	-	- V	
	Drain-Source Breakdown Voltage	I _D =250µA, V _{GS} =0V, T _J =150°C	-	700	-		
BV _{DSS} /∆TJ	Breakdown Voltage Temperature Coefficient	I _D =250μΑ, V _{GS} =0V	-	0.59	-	V/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V	-	-	1		
	Zero Gale voltage Drain Current	V _{DS} =480V, T _J =125°C	-	-	10	0 μA	
I _{GSS}	Gate-Body leakage current	$V_{DS}=0V, V_{GS}=\pm 20V$	-	-	±100	nA	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, I _D =250μA	3.2	4	4.6	V	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =7.6A	-	0.17	0.19	Ω	
g _{FS}	Forward Transconductance	V _{DS} =10V, I _D =10A	-	16	-	S	
V_{SD}	Diode Forward Voltage	I _S =10A,V _{GS} =0V	-	0.85	1.2	V	
I _S	Maximum Body-Diode Continuous Current			-	20	А	
I _{SM}	Maximum Body-Diode Pulsed Current ^C			-	80	Α	
	IC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	1935	-	pF	
C _{oss}	Output Capacitance	$V_{GS} = 0.0$, $V_{DS} = 100.0$, $1 = 100.12$	-	55	-	pF	
C _{o(er)}	Effective output capacitance, energy related ^H	V _{GS} =0V, V _{DS} =0 to 480V, f=1MHz	-	49	-	pF	
C _{o(tr)}	Effective output capacitance, time related ¹		-	213	-	pF	
C _{rss}	Reverse Transfer Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	1.25	-	pF	
R _g	Gate resistance	f=1MHz	-	5	-	Ω	
SWITCH	ING PARAMETERS						
Q_{g}	Total Gate Charge		-	34	-	nC	
Q_{gs}	Gate Source Charge	V_{GS} =10V, V_{DS} =480V, I_{D} =10A	-	12	-	nC	
Q_{gd}	Gate Drain Charge		-	11	-	nC	
t _{D(on)}	Turn-On DelayTime		-	49	-	ns	
t _r	Turn-On Rise Time	V _{GS} =10V, V _{DS} =400V, I _D =10A,		40	-	ns	
t _{D(off)}	Turn-Off DelayTime	$R_G=25\Omega$	-	115	-	ns	
t _f	Turn-Off Fall Time		-	26	-	ns	
t _{rr}	Body Diode Reverse Recovery Time		-	341	-	ns	
l _{rm}	Peak Reverse Recovery Current	I _F =10A, dl/dt=100A/µs, V _{DS} =400V	-	28	-	А	
Q _{rr}	Body Diode Reverse Recovery Charg	e	-	6.8	-	μC	

A. The value of R $_{\scriptscriptstyle 0JA}$ is measured with the device in a still air environment with T $_{A}$ =25 $^{\circ}~$ C.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C, Ratings are based on low frequency and duty cycles to keep initial T_{J} =25° C.

 D. The R _{6UA} is the sum of the thermal impedance from junction to case R _{6UC} and case to ambient.
 E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
 F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.

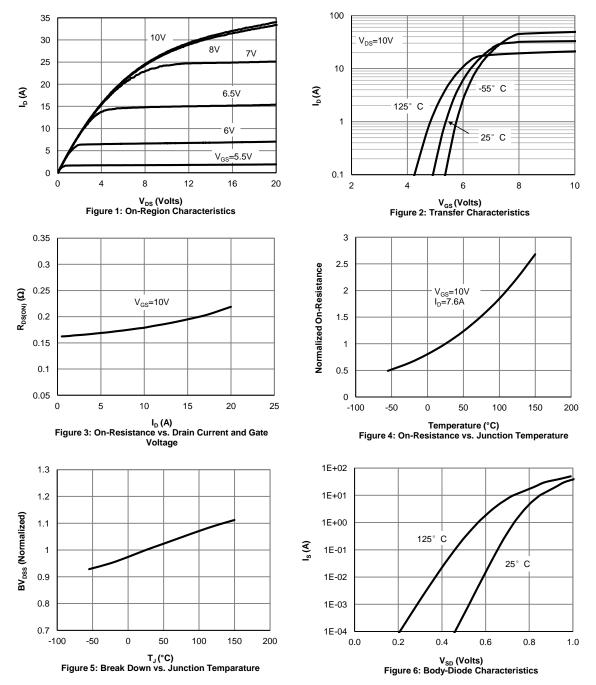
G. L=60mH, I_{AS}=3.7A, V_{DD}=150V, R_G=25 Ω , Starting T_J=25° C.

 $I. C_{o(er)} is a fixed capacitance that gives the same charging time as <math>C_{oss}$ while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$. I. $C_{o(er)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.

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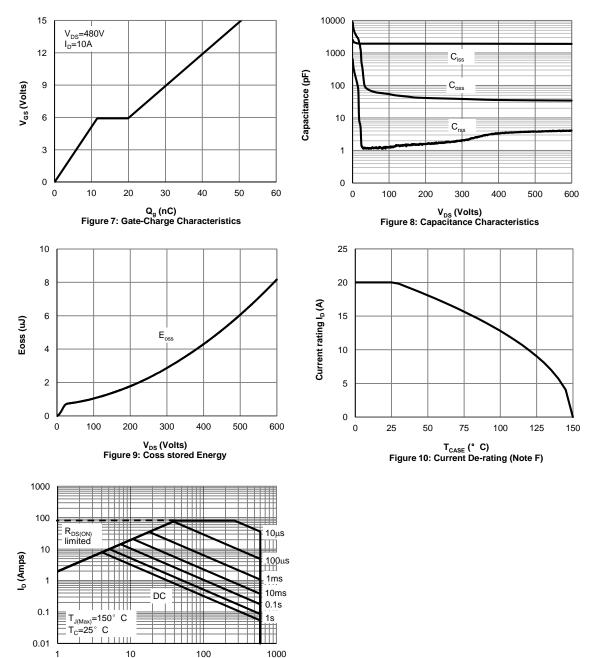


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





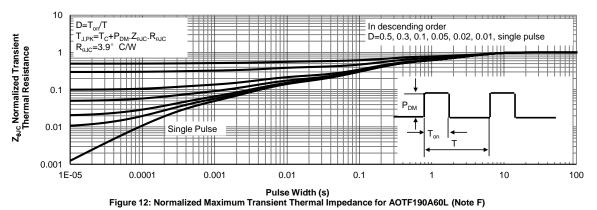
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V_{DS} (Volts) Figure 11: Maximum Forward Biased Safe Operating Area for AOTF190A60L (Note F)

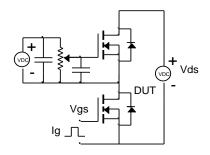


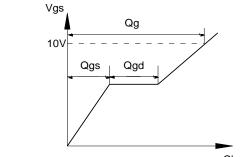
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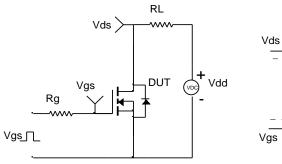
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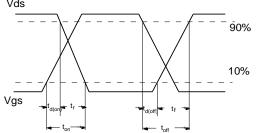




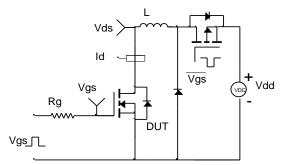
Charge

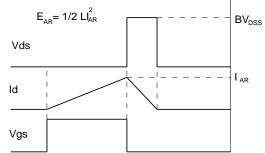
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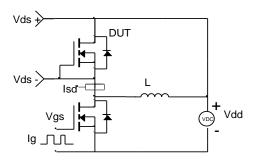


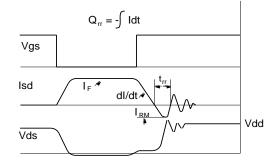
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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